

UNISONIC TECHNOLOGIES CO., LTD

3N70K-MT Power MOSFET

3A, 700V N-CHANNEL POWER MOSFET

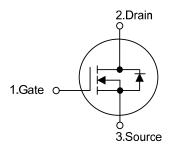
DESCRIPTION

The UTC 3N70K-MT is a high voltage and high current power MOSFET, designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

FEATURES

- * $R_{DS(ON)}$ < 4.00 @ V_{GS} = 10 V, I_{D} = 1.5 A
- * Low reverse transfer capacitance
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

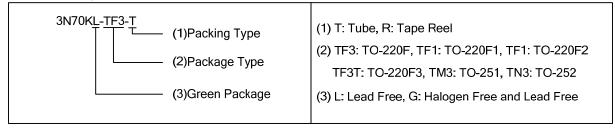
SYMBOL



ORDERING INFORMATION

Ordering Number		Dookowa	Pin Assignment			Doolsing	
Lead Free	Halogen Free	Package	1	2	3	Packing	
3N70KL-TF3-T	3N70KG-TF3-T	TO-220F	G	D	S	Tube	
3N70KL-TF1-T	3N70KG-TF1-T	TO-220F1	G	D	S	Tube	
3N70KL-TF2-T	3N70KG-TF2-T	TO-220F2	G	D	S	Tube	
3N70KL-TF3T-T	3N70KG-TF3T-T	TO-220F3	G	D	S	Tube	
3N70KL-TM3-T	3N70KG-TM3-T	TO-251	G	D	S	Tube	
3N70KL-TN3-R	3N70KG-TN3-R TO-252 G D		D	S	Tape Reel		

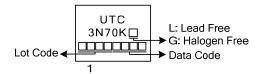
Note: Pin Assignment: G: Gate D: Drain S: Source



TO-220F TO-220F1 TO-220F2 TO-220F3 TO-251

www.unisonic.com.tw 1 of 8 3N70K-MT

■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	700	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Avalanche Current (Note 2)		I _{AR}	3.0	Α	
Continuous Drain Current		I _D	3.0	Α	
Pulsed Drain Current (Note 2)		I _{DM}	12	Α	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	90	mJ	
	Repetitive (Note 2)	E _{AR}	7.5	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns	
Power Dissipation	TO-220F/TO-220F1		34		
	TO-220F2/TO-220F3	P_D	35	W	
	TO-251/TO-252		50		
Junction Temperature		TJ	+150	°C	
Operating Temperature		T _{OPR}	-55 ~ + 150	°C	
Storage Temperature		T _{STG}	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 20mH, I_{AS} = 3A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C
- 4. $I_{SD} \leq 3.0 A$, di/dt $\leq 200 A/\mu s$, $V_{DD} \leq BV_{DSS}$, Starting T_J = 25°C

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220F/TO-220F1/ TO-220F2/TO-220F3	θја	62.5	°C/W
	TO-251/TO-252		110	°C/W
Junction to Case	TO-220F/TO-220F1		3.68	°C/W
	TO-220F2/TO-220F3	θ_{JC}	3.58	°C/W
	TO-251/TO-252		2.5	°C/W

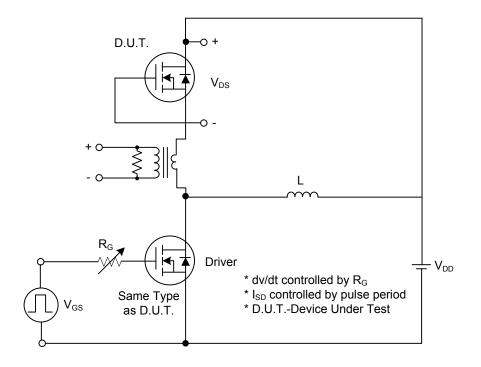
■ **ELECTRICAL CHARACTERISTICS** (T_C =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	700			V	
Drain-Source Leakage Current		I _{DSS}	V _{DS} = 700 V, V _{GS} = 0 V			10	μA	
Cata Sauras Laglaga Current Fo	orward	1000	V _{GS} = 30 V, V _{DS} = 0 V			100	nA	
Gate-Source Leakage Current	everse		$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA	
Breakdown Voltage Temperature Co	efficient	$\triangle BV_{DSS}/\triangle T_{J}$	I _D = 250μA,Referenced to 25°C		0.6		V/°C	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} = 10 V, I _D = 1.5A		3.31	4.0	Ω	
DYNAMIC CHARACTERISTICS								
Input Capacitance		C_{ISS}	S 1/ 051/1/ 01/		330	510	pF	
Output Capacitance		C	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1MHz		40	65	pF	
Reverse Transfer Capacitance		C_{RSS}			5.18	16	pF	
SWITCHING CHARACTERISTICS								
Turn-On Delay Time		$t_{D(ON)}$			42	60	ns	
Turn-On Rise Time		t_{R}	$V_{DD} = 30V, I_D = 0.5A,$		26	50	ns	
Turn-Off Delay Time		$t_{D(OFF)}$	$R_G = 25\Omega \text{ (Note 1, 2)}$		65	130	ns	
Turn-Off Fall Time		t_{F}			40	70	ns	
Total Gate Charge		Q_G	V _{DS} = 50V,I _D = 1.3A,		13	16	nC	
Gate-Source Charge		Q_GS	V _{DS} = 50 V,I _D = 1.5A, V _{GS} = 10 V (Note 1, 2)		4.9		nC	
Gate-Drain Charge		Q_GD	V _{GS} - 10 V (NOte 1, 2)		3.0		nC	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Drain-Source Diode Forward Voltage		V_{SD}	$V_{GS} = 0 \text{ V}, I_{S} = 3.0 \text{ A}$			1.4	V	
Maximum Continuous Drain-Source Diode		1-				3.0	Α	
Forward Current		Is				3.0	Α	
Maximum Pulsed Drain-Source Diode Forward Current		I _{SM}				12	Α	
						12	^	

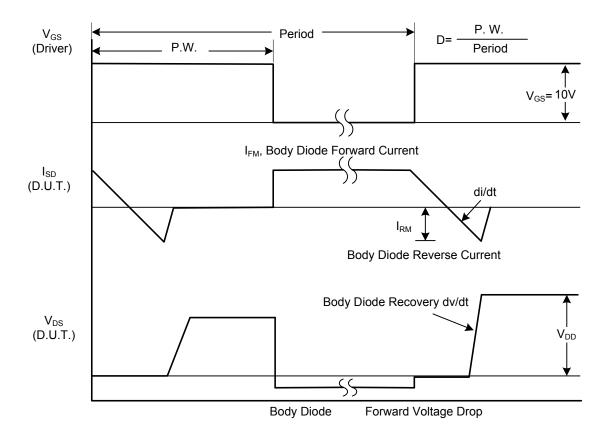
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle≤2%

^{2.} Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS



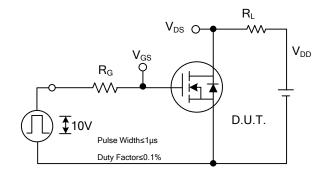
Peak Diode Recovery dv/dt Test Circuit

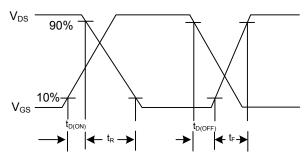


Peak Diode Recovery dv/dt Waveforms

3N70K-MT Power MOSFET

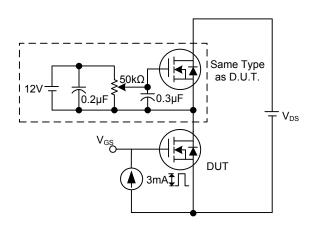
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

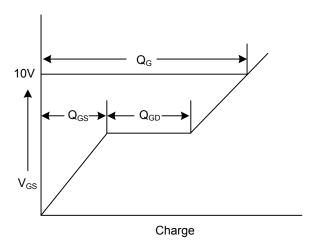




Switching Test Circuit

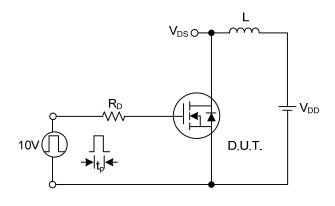
Switching Waveforms

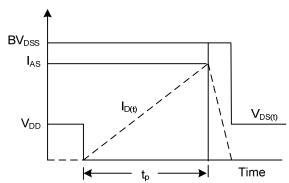




Gate Charge Test Circuit

Gate Charge Waveform



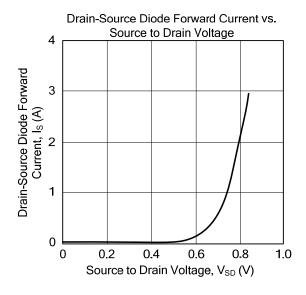


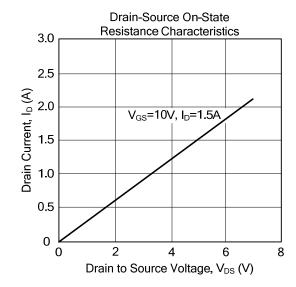
Unclamped Inductive Switching Test Circuit

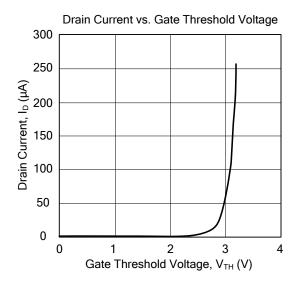
Unclamped Inductive Switching Waveforms

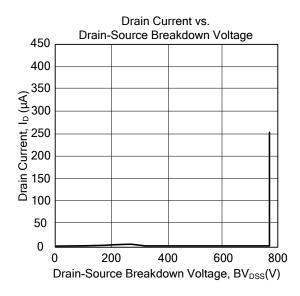
3N70K-MT Power MOSFET

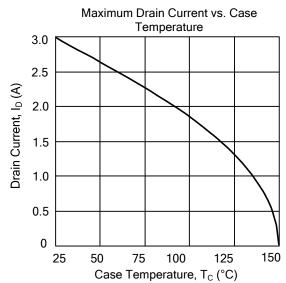
■ TYPICAL CHARACTERISTICS











UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice.